

ELECTRIC FIELD EFFECT ON SUPERCONDUCTING $\text{YBa}_2\text{Cu}_3\text{O}_{7-\delta}$ FILMS

J. MANNHART, D.G. SCHLOM, J.G. BEDNORZ, and K.A. MÜLLER

IBM Research Division, Zurich Research Laboratory, 8803 Rüschlikon, Switzerland

MISFET-type structures have been developed that allow the application of electric fields larger than $4 \times 10^6 \text{ V/cm}$ into 100 Å thick, superconducting $\text{YBa}_2\text{Cu}_3\text{O}_{7-\delta}$ channel layers. With these structures, the carrier density and the electrical resistivity of $\text{YBa}_2\text{Cu}_3\text{O}_{7-\delta}$ can be modified in the percent range by gate voltages of 50 V.

1. INTRODUCTION

Shortly after the discovery of high- T_c superconductivity, these materials were predicted to exhibit an electric field effect much stronger than conventional low- T_c superconductors.¹ This expectation and subsequent suggestions for applications are based on the idea that the length scale by which external electrostatic fields are shielded in the depletion mode is the Debye length $L_D \propto n^{-1/2}$, where n is the density of mobile carriers. In high- T_c cuprates, where $n \approx 3\text{-}5 \times 10^{21}/\text{cm}^3$, screening lengths of a few Å are expected. Furthermore, the short coherence length of high- T_c cuprates, allows the fabrication of ultrathin layers, which may be substantially penetrated by electric fields. Encouraged by such considerations, numerous studies on the electric field effect in high- T_c compounds have been performed.^{2,3}

Here, field effect studies are reported that take advantage of epitaxially grown SrTiO_3 films incorporated into an inverted MISFET-type structure as shown in Fig. 1. A superconducting $\text{YBa}_2\text{Cu}_3\text{O}_{7-\delta}$ film of thickness s is separated from a gate electrode by the insulating SrTiO_3 layer of thickness t . Such a configuration allows considerable positive (negative) voltages V_G to be applied between the gate electrode and the superconductor in order to decrease (enhance) its density of mobile holes.

2. SAMPLE PREPARATION

In most of the heterostructures investigated, the gate electrode consists of an n -type (100) oriented 0.05% Nb-doped SrTiO_3 single crystal grown by the zone melting technique. On top of this crystal, (100)-oriented SrTiO_3 is grown by rf-magnetron sputtering at 0.05 Torr in an Ar/O_2 atmosphere. Without breaking vacuum, $\text{YBa}_2\text{Cu}_3\text{O}_{7-\delta}$ films were grown epitaxially on top of the SrTiO_3 layers by hollow cathode magnetron sputtering. Contacts were provided by Au pads.³

3. RESULTS

The insulating barriers have resistivities of up to $1 \times 10^{13} \Omega\text{cm}$ at a forward bias of 3 V, and up to $1 \times 10^{14} \Omega\text{cm}$ at a reverse bias of 20 V, allowing the channel layer resistance R_{DS} to be measured without interference by excessive gate leakage current.

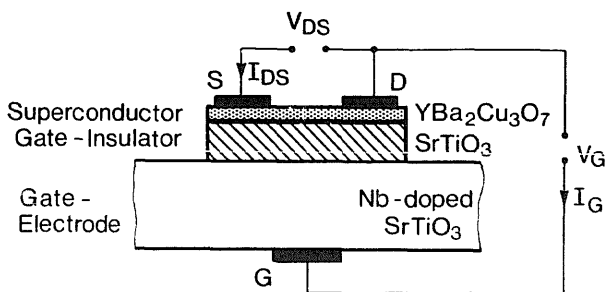


FIGURE 1. Sketch of the inverted MISFET-structure (cross section).

Breakdown fields E_{BD} of 2×10^5 V/cm and 4×10^6 V/cm were obtained at 300 K in the forward and reverse direction, respectively. At lower temperature, E_{BD} decreases, indicating avalanche breakdown. Barrier capacitances of 2×10^{-7} F/cm² are obtained at 300 K, corresponding to a dielectric constant ϵ_r of 40. Resistivity data are obtained by a current-biased four-point measurement in dc-mode. For each data point the polarity of the current source was reversed and the results averaged.

The effect of the gate voltage on the drain-source resistance at room temperature is shown in Fig. 2 for a sample with $s \approx 100$ Å, $t \approx 1600$ Å and T_c ($R = 0$) ≈ 70 K. The figure — characteristic for all samples investigated — shows that the normal-state resistivity of the $\text{YBa}_2\text{Cu}_3\text{O}_{7-\delta}$ film depends linearly on gate voltage, that the sign of ΔR_{DS} depends on the polarity of V_G , and that changes in resistivity of more than 1% are obtained for electric fields above 2×10^6 V/cm. Hysteresis effects as shown in Fig. 2 have been found to be consistent with trapping of charges close to the $\text{YBa}_2\text{Cu}_3\text{O}_{7-\delta}/\text{SrTiO}_3$ interface. The relative change $\Delta R_{\text{DS}}/R_{\text{DS}}$ is constant as a function of temperature for the samples investigated, leading to a shift of $R_{\text{DS}}(T)$ at midpoint T_c (≈ 82.5 K) of ≈ 50 mK for $V_G = 18$ V. Further characteristics have been described elsewhere.³

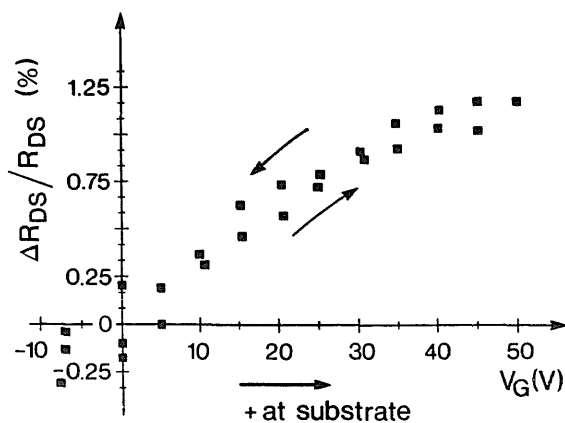


FIGURE 2. Change of the normal state resistance of the $\text{YBa}_2\text{Cu}_3\text{O}_{7-\delta}$ layer caused by the electric field of an applied gate voltage V_G at 300 K.

4. DISCUSSION

The measured $R_{\text{DS}}(V_G)$ agrees well with expectations: Applying 30 V to the sample shown in Fig. 2 with a capacitance of $\approx 2 \times 10^{-7}$ F/cm² induces a change in the electron density in the channel layer of $\approx 4 \times 10^{13}$ /cm². On the other hand, $\text{YBa}_2\text{Cu}_3\text{O}_{7-\delta}$ has a carrier density of $\approx 3.5 \times 10^{21}$ /cm³, which corresponds to a density of mobile holes in the channel layer of 3.5×10^{15} /cm². Therefore, within experimental error, a change in the carrier density of $\approx 1\%$ results in an equal change of R_{DS} .

It is pointed out that the observed field effect greatly exceeds the values reported previously for superconducting high- T_c cuprates. Optimizing the sample configuration may allow us the control of the carrier concentration in superconducting channels to an even greater extent. The occurrence of a significant electric-field effect in high- T_c superconductors may open a route to new experiments concerning fundamental properties of high- T_c compounds, for example, by changing the carrier concentration in a given sample in a well-controlled manner without affecting its stoichiometry. Also, a sufficiently strong electric-field effect may provide a basis for future applications of high- T_c superconductors.

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